

Day : Tuesday
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Inventor Name Search Result

Your Search was:

Last Name = LEE

First Name = CHENG-YIN

Application#	Patent#	Status	Date Filed	Title	Inventor Name
09588533	6879594	150	06/07/2000	SYSTEM AND METHOD FOR LOOP AVOIDANCE IN MULTI-PROTOCOL LABEL SWITCHING	LEE, CHENG-YIN
09753069	6915325	150	01/02/2001	METHOD AND PROGRAM CODE FOR COMMUNICATING WITH A MOBILE NODE THROUGH TUNNELS	LEE, CHENG-YIN
10226050	Not Issued	93	08/23/2002	EXTENSIBLE OAM SUPPORT IN MPLS/ATM NETWORKS	LEE, CHENG-YIN
10230294	Not Issued	161	08/29/2002	Scalable path protection for meshed networks	LEE, CHENG-YIN
10369567	Not Issued	61	02/21/2003	Prohibit or avoid route mechanism for path setup	LEE, CHENG-YIN
10369568	Not Issued	41	02/21/2003	Customer site bridged emulated LAN services via provider provisioned connections	LEE, CHENG-YIN
10604791	Not Issued	161	08/18/2003	[SEMICONDUCTOR PACKAGE MODULE AND MANUFACTURING MEHOD THEREOF]	LEE, CHENG-YIN
10657230	6815833	150	09/09/2003	FLIP CHIP PACKAGE	LEE, CHENG-YIN
10664981	Not Issued	161	09/22/2003	Semiconductor package with thermal enhance film and manufacturing method thereof	LEE, CHENG-YIN
10690743	Not Issued	161	10/23/2003	System in package structure	LEE, CHENG-YIN
10724775	Not Issued	30	12/02/2003	Hybrid virtual private LAN extensions	LEE, CHENG-YIN
10796968	Not Issued	30	03/11/2004	Ethernet path verification	LEE, CHENG-YIN

<u>10868496</u>	<u>7122757</u>	150	06/14/2004	CONTACT SENSOR PACKAGE STRUCTURE	LEE, CHENG-YIN
<u>10904574</u>	<u>7061079</u>	150	11/17/2004	CHIP PACKAGE STRUCTURE AND MANUFACTURING METHOD THEREOF	LEE, CHENG-YIN
<u>10907561</u>	Not Issued	161	04/06/2005	SEMICONDUCTOR PACKAGE MODULE AND MANUFACTURING METHOD THEREOF	LEE, CHENG-YIN
<u>10911692</u>	Not Issued	30	08/05/2004	Method for forwarding traffic having a predetermined category of transmission service in a connectionless communications network	LEE, CHENG-YIN
<u>10934409</u>	<u>7187070</u>	150	09/07/2004	STACKED PACKAGE MODULE	LEE, CHENG-YIN
<u>11009917</u>	Not Issued	30	12/10/2004	Virtual private network connection methods and systems	LEE, CHENG-YIN
<u>11020437</u>	Not Issued	30	12/22/2004	Virtual private networking methods and systems	LEE, CHENG-YIN
<u>11020503</u>	Not Issued	30	12/23/2004	Method and apparatus for configuring a communication path	LEE, CHENG-YIN
<u>11058274</u>	Not Issued	30	02/16/2005	IP to VPLS interworking	LEE, CHENG-YIN
<u>11210700</u>	Not Issued	61	08/25/2005	Method for stacking BGA packages and structure from the same	LEE, CHENG-YIN
<u>11224057</u>	Not Issued	30	09/13/2005	Low latency working VPLS	LEE, CHENG-YIN
<u>11306818</u>	Not Issued	30	01/12/2006	MULTI-CHIP PACKAGE STRUCTURE	LEE, CHENG-YIN
<u>11332293</u>	Not Issued	71	01/17/2006	Multi-chip package structure	LEE, CHENG-YIN
<u>11420230</u>	Not Issued	30	05/25/2006	SYSTEM-IN-PACKAGE STRUCTURE	LEE, CHENG-YIN
<u>11463404</u>	Not Issued	30	08/09/2006	CHIP PACKAGE STRUCTURE	LEE, CHENG-YIN
<u>11505325</u>	Not Issued	30	08/17/2006	Die package and method for making the same	LEE, CHENG-YIN
<u>11520769</u>	Not Issued	30	09/14/2006	Multi-chip package structure	LEE, CHENG-YIN
<u>11634059</u>	Not Issued	30	12/06/2006	Substrate structure having a solder mask and a process for making the	LEE, CHENG-YIN

				same	
<u>11636975</u>	Not Issued	30	12/12/2006	Stackable semiconductor package	LEE, CHENG-YIN
<u>11636986</u>	Not Issued	30	12/12/2006	Stackable semiconductor package	LEE, CHENG-YIN
<u>11636993</u>	Not Issued	30	12/12/2006	Stackable semiconductor package	LEE, CHENG-YIN
<u>11637786</u>	Not Issued	30	12/13/2006	Manufacturing method of a package structure	LEE, CHENG-YIN
<u>11744189</u>	Not Issued	17	05/03/2007	Semiconductor package	LEE, CHENG-YIN
<u>11828351</u>	Not Issued	17	07/26/2007	Semiconductor package and semiconductor device	LEE, CHENG-YIN
<u>11828352</u>	Not Issued	17	07/26/2007	Method of making a semiconductor package and method of making a semiconductor device	LEE, CHENG-YIN
<u>60137717</u>	Not Issued	159	06/07/1999	METHOD FOR AVOIDING LOOPS IN MPLS	LEE, CHENG-YIN
<u>60188811</u>	Not Issued	159	03/13/2000	Apparatus and method of communicating between a mobile network device and a correspondent network device	LEE, CHENG-YIN

Inventor Search Completed: No Records to Display.

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